AUTOMOTIV

COMPLIANT

HALOGEN FREE

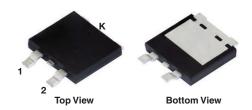


Vishay General Semiconductor

Dual Low-Voltage TMBS® (Trench MOS Barrier Schottky) Rectifier

Ultra Low $V_F = 0.31 \text{ V}$ at $I_F = 5.0 \text{ A}$

eSMP[®] Series SMPD (TO-263AC)





LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS				
I _{F(AV)}	2 x 15 A			
V _{RRM}	60 V			
I _{FSM}	200 A			
V_F at $I_F = 15 \text{ A } (T_J = 125 ^{\circ}\text{C})$	0.47 V			
T _J max.	150 °C			
Package	SMPD (TO-263AC)			
Circuit configuration	Common cathode			

FEATURES

- Trench MOS Schottky technology
- Very low profile typical height of 1.7 mm
- Ideal for automated placement
- · Low forward voltage drop, low power losses
- · High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available:
 - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

For use in high frequency DC/DC converters, switching power supplies, freewheeling diodes, OR-ing diode, and reverse battery protection in commercial, industrial, and automotive application.

MECHANICAL DATA

Case: SMPD (TO-263AC)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and

AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

M3 and HM3 suffix meet JESD 201 class 2 whisker test

Polarity: as marked

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)					
PARAMETER		SYMBOL	V30DL63CL	UNIT	
Device marking code			V30DL63CL		
Maximum repetitive peak reverse voltage		V_{RRM}	60	V	
Maximum average forward rectified current (fig. 1)	per device	ı (1)	30	^	
	per diode	I _{F(AV)} ⁽¹⁾	15	A	
Peak forward surge current 8.3 ms single half superimposed on rated load per diode	sine-wave	I _{FSM}	200	А	
Operating junction temperature range		T _J ⁽²⁾	-40 to +150	°C	
Storage temperature range		T _{STG}	-55 to +150		

Notes

- (1) Mounted on infinite heatsink
- (2) The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta,IA}$



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ELECTRICAL CHARACTERISTICS (T _J = 25 °C unless otherwise noted)							
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT	
Instantaneous forward voltage per diode	I _F = 5 A	T _J = 25 °C	V _F ⁽¹⁾	0.42	-	- V	
	$I_F = 7.5 A$			0.45	-		
	I _F = 15 A			0.52	0.58		
	I _F = 5 A	T _J = 125 °C		0.31	-		
	$I_F = 7.5 A$			0.35	-		
	I _F = 15 A			0.47	0.55		
Reverse current at rated V _R per diode	V _R = 60 V	T _J = 25 °C	I _R (2)	-	0.5	- mA	
	v _R = 00 v	T _J = 125 °C		15	35		
Typical junction capacitance per diode	4.0 V, 1 MHz		CJ	3200	-	pF	

Notes

 $^{(1)}$ Pulse test: 300 μ s pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 5 ms

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL	V30DL63CL	UNIT		
Typical thermal resistance per device	R ₀ JC ⁽¹⁾	1.6	°C/W		
	R _{0JA} (2)(3)	50	C/VV		

Notes

- (1) Mounted on infinite heatsink
- $^{(2)} \ \ \, \text{The heat generated must be less than the thermal conductivity from junction-to-ambient:} \ dP_D/dT_J < 1/R_{\theta JA} \text{junction-to-ambient}$
- (3) Free air, without heatsink

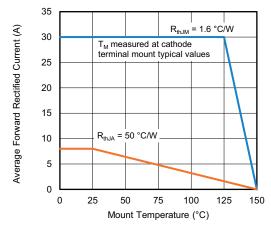
ORDERING INFORMATION (Example)						
PREFERRED P/N	UNIT WEIGHT (g)	PACKAGE CODE	BASE QUANTITY	DELIVERY MODE		
V30DL63CL-M3/I	0.55	I	2000/reel	13" diameter plastic tape and reel		
V30DL63CLHM3/I (1)	0.55	I	2000/reel	13" diameter plastic tape and reel		

Note

(1) AEC-Q101 qualified

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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)



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Fig. 1 - Maximum Forward Current Derating Curve

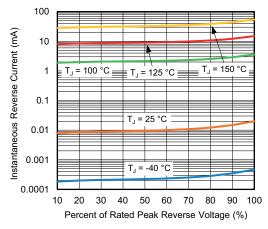


Fig. 4 - Typical Reverse Leakage Characteristics Per Diode

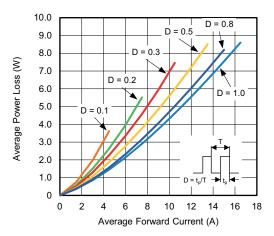


Fig. 2 - Average Power Loss Characteristics Per Diode

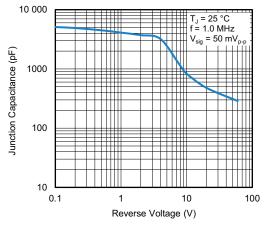


Fig. 5 - Typical Junction Capacitance Per Diode

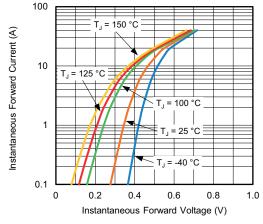


Fig. 3 - Typical Instantaneous Forward Characteristics Per Diode

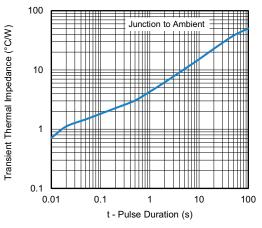


Fig. 6 - Typical Transient Thermal Impedance

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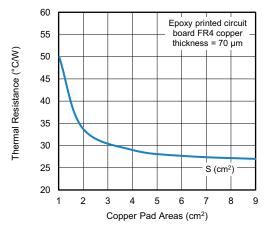
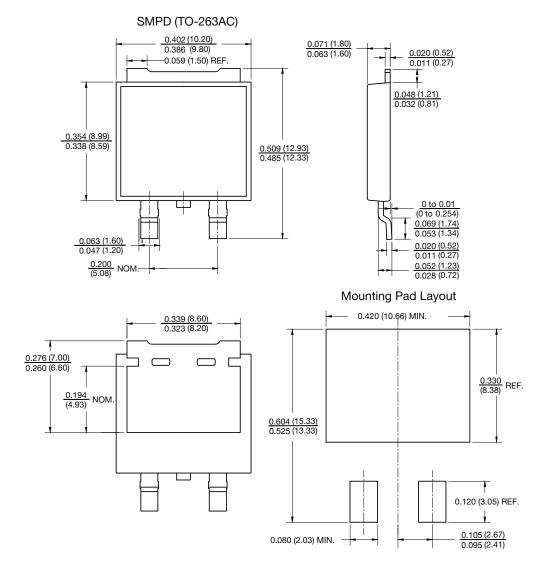


Fig. 7 - Thermal Resistance Junction-to-Ambient vs. Copper Pad Areas

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





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